

PATENTS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Hirokazu HONDA

Serial No. 09/678,609

GROUP 2814

Filed October 4, 2000

Examiner D. Graybill

MULTILAYER INTERCONNECTION BOARD,
SEMICONDUCTOR DEVICE HAVING THE SAME,
AND METHOD OF FORMING THE SAME AS
WELL AS METHOD OF MOUNTING THE
SEMICONDUCTOR CHIP ON THE INTERCONNECTION
BOARD

AMENDMENT

Commissioner for Patents

Washington, D.C. 20231

Sir:

Responsive to the Official Action of December 3, 2001,
please amend the above-identified application as follows:

IN THE CLAIMS:

Cancel claims 60-79.

R E M A R K S

Responsive to the requirement for restriction,
Applicant elects Group I, claims 1-59, drawn to the product,
without traverse.

Non-elected claims 60-79 are cancelled herewith, but
may of course be made the subject of a divisional application to
be filed at any time during the pendency of the present
application.

Election
4/A

1-4-02

T. Flower

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DEC 31 2001
TECHNOLOGY CENTER 2800


HONDA S.N. 09/678,609

An action on the merits of the elected claims is respectfully requested.

Respectfully submitted,

YOUNG & THOMPSON

By



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December 27, 2001